

ROHS EARTH FRIEND

THI FRIENDLY

SMT GaAs MMIC x2 ACTIVE FREQUENCY MULTIPLIER, 8 - 22 GHz OUTPUT

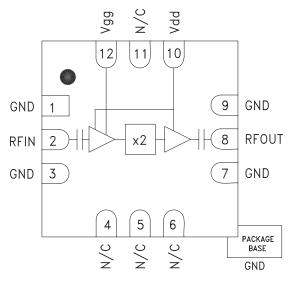
HMC573LC3B

Typical Applications

The HMC573LC3B is suitable for:

- Clock Generation Applications: SONET OC-192 & SDH STM-64
- Point-to-Point & VSAT Radios
- Test Instrumentation
- Military & Space

Functional Diagram



Features High Output Power: +12 dBm Low Input Power Drive: 0 to +6 dBm Fo Isolation: >20 dBc @ Fout= 16 GHz 100 KHz SSB Phase Noise: -134 dBc/Hz Single Supply: +5V@ 92 mA RoHS Compliant 3x3 mm SMT Package

General Description

The HMC573LC3B is a x2 active broadband frequency multiplier utilizing GaAs PHEMT technology in a leadless RoHS compliant SMT package. When driven by a +5 dBm signal, the multiplier provides +12 dBm typical output power from 8 to 22 GHz. The Fo and 3Fo isolations are >20 dBc and >25 dBc respectively at 16 GHz. The HMC573LC3B is ideal for use in LO multiplier chains for Pt to Pt & VSAT Radios yielding reduced parts count vs. traditional approaches. The low additive SSB Phase Noise of -134 dBc/Hz at 100 kHz offset helps maintain good system noise performance. The RoHS packaged HMC573LC3B eliminates the need for wire bonding, and allows the use of surface mount manufacturing techniques.

Electrical Specifications, $T_A = +25^{\circ}C$, Vdd = +5V, 5 dBm Drive Level

Parameter		Тур.	Max.	Units
Frequency Range, Input		4 - 11		
Frequency Range, Output		8 - 22		
Output Power		12		dBm
Fo Isolation (with respect to output level)		20		dBc
3Fo Isolation (with respect to output level)		25		dBc
4Fo Isolation (with respect to output level)		15		dBc
Input Return Loss		10		dB
Output Return Loss		10		dB
SSB Phase Noise (100 kHz Offset)		-134		dBc/Hz
Supply Current (Idd) (Vdd = 5V, Vgg = -1.25V Typ.)		92		mA

*Adjust Vgg between -1.5 and ~1.1V to achieve Idd = 92 mA

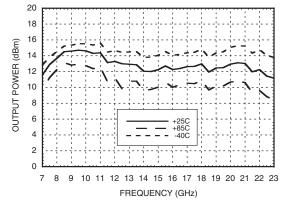


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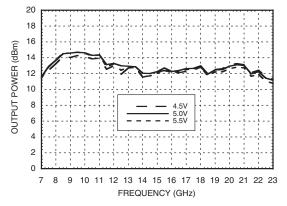


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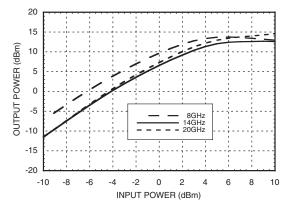
Output Power vs. Temperature @ 5 dBm Drive Level



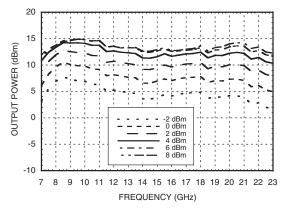
Output Power vs. Supply Voltage @ 5 dBm Drive Level



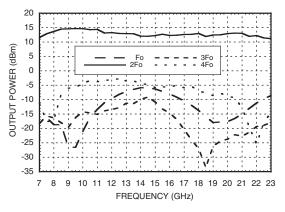
Output Power vs. Input Power



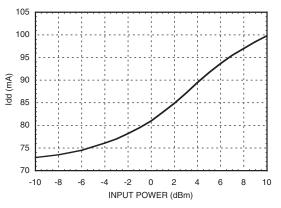
Output Power vs. Drive Level



Isolation @ 5 dBm Drive Level



Supply Current vs. Input Power



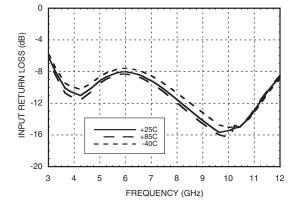




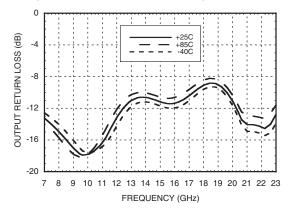


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Input Return Loss vs. Temperature



Output Return Loss vs. Temperature





HMC573LC3B



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Absolute Maximum Ratings

RF Input (Vdd = +5V)	+10 dBm
Supply Voltage (Vdd)	+6.0 Vdc
Channel Temperature	175 °C
Continuous Pdiss (T= 85 °C) (derate 8.0 mW/°C above 85 °C)	719 mW
Thermal Resistance (channel to ground paddle)	125 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vdd

Vdd (Vdc)	ldd (mA)
4.5	90
5.0	92
5.5	94

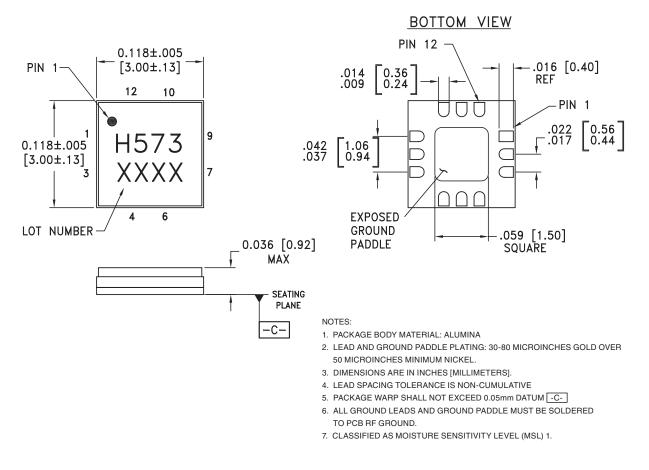
Note:

Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing





HMC573LC3B

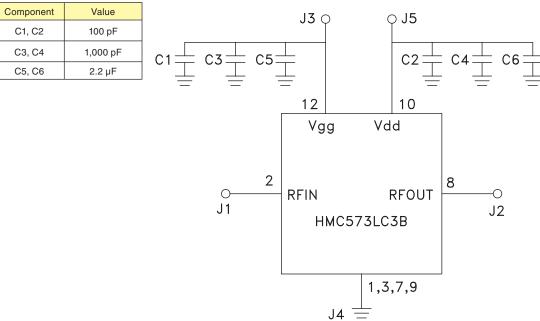


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Pin Description

Pin Number	Function	Description	Interface Schematic
1, 3, 7, 9	GND	Package bottom must also be connected to RF/DC ground.	
2	RFIN	Pin is AC coupled and matched to 50 Ohms.	
4 - 6, 11	N/C	These pins are internally not connected; however, this product was specified with these pins connected to RF/ DC ground.	
8	RFOUT	Pin is AC coupled and matched to 50 Ohms.	
10	Vdd	Supply voltage 5V \pm 0.5V. External bypass capacitors of 100 pF, 1,000 pF and 2.2 μF are required.	Vdd
12	Vgg	Gate control for amplifier. Adjust to achieve Idd of 92 mA. Please follow "MMIC Amplifier Blasing Procedure" Application note.	Vgg o

Application Circuit



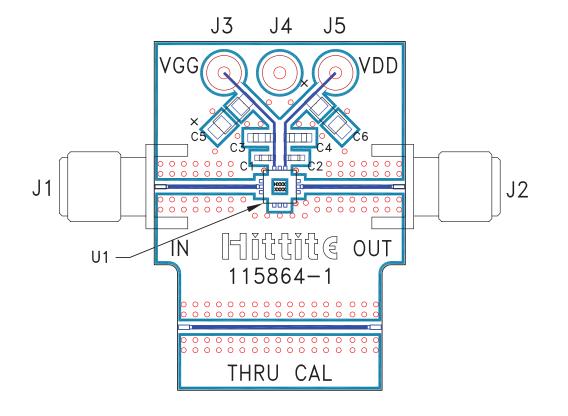
For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com





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Evaluation PCB



List of Materials for Evaluation PCB 115739^[1]

Item	Description
J1, J2	PCB Mount SRI K Connector
J3 - J5	DC Pin
C1, C2	100 pF Capacitor, 0402 Pkg.
C3, C4	1,000 pF Capacitor, 0603 Pkg.
C5, C6	2.2 µF Tantalum Capacitor
U1	HMC573LC3B x2 Active Multiplier
PCB [2]	115864 Eval Board

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.